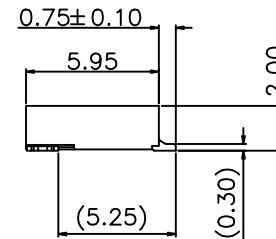
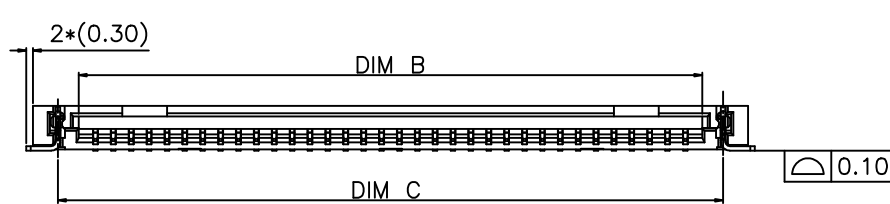
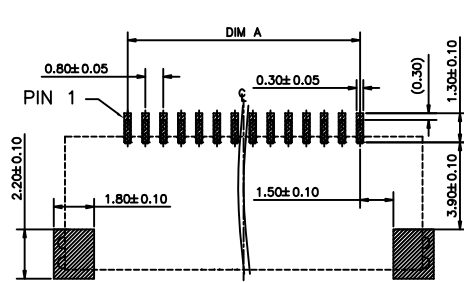
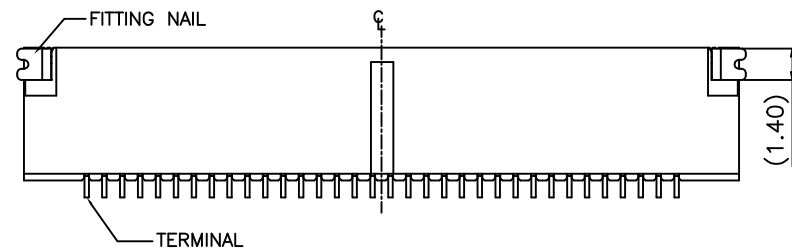


- NOTES:
- MATERIAL:
 - HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0;
 - ACTUATOR: THERMOPLASTIC, HIGH TEMP., UL94V-0;
 - CONTACT: COPPER ALLOY
 - FITTING NAIL: COPPER ALLOY
 - FINISH:
 - CONTACT:
 - 50u" MIN NICKEL UNDERPLATING OVERALL.
 - W:1u" MIN GOLD PLATING ON CONTACT AREA;
 - GOLD FLASH PLATING ON SOLDER AREA
 - FITTING NAIL:
 - 50u" MIN NICKEL UNDERPLATING OVERALL.
 - 80u" MIN MATT TIN PLATING (LEAD FREE).
 - REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.
 - SPEC. PLS. REFER TO PS-52533-xxxxx-xxx
 - PACKAGE PLS REFER TO 52533-xxxx-xx-TRP
 - PART NUMBER

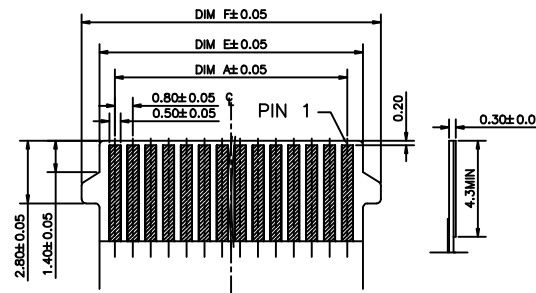


52533-XXX X X-XXX

NO OF CKT	PACKING	PLATING	HOUSING MATERIAL&COLOR		ACTUATOR MATERIAL&COLOR	
			001	HALOGEN FREE PLASTIC & NATURAL	HALOGEN FREE PLASTIC & BLACK	
O: TAPE & REEL		1:GOLD FLASH ON CONTACT AREA				



RECOMMENDED PCB LAYOUT



RECOMMENDED FPC/FFC DIMENSIONS

CKT	DIM A	DIM B	DIM C	DIM D	DIM E	DIM F
34	26.40	27.90	29.77	32.00	27.80	29.40

QUALITY SYMBOLS	DRAWN BY	DATE				
MAJOR	Sun,Ya Jie	23/10/11				
CRITICAL	CHECKED BY	DATE				
	Xu,Zhi Yong	23/10/11				
GENERAL TOLERANCES (UNLESS SPECIFIED)	APPROVED BY	DATE	TITLE			
X. ±0.5	Xu,Zhi Yong	23/10/11	0.8mm Easy On FPC Conn.			
.X ±0.20			SMT R/A B/C Type			
.XX ±0.15	UNITS	mm	SIZE	A4	DWG NO.	N/A
.XXX ±0.1	SCALE	1 : 1	REV	B	PART NO.	52533-XXXXX-XXX
ANGLES ±2°	SHEET NO.	1 OF 1				